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TABLE OF CONTENTS

BLACK-BOX OPTIMIZATION OF 3D INTEGRATED SYSTEMS USING MACHINE LEARNING	1
<i>Hakki M. Torun ; Madhavan Swaminathan</i>	
MATRIX FORMULATIONS & GPU ACCELERATION FOR HIGH-SPEED DIGITAL LINK SIMULATIONS	4
<i>Sunil Sudhakaran ; Arash Zargarani-Yazd</i>	
SIGNAL SLOPE MODULATION METHOD FOR HIGH DATA TRANSFER RATES AND REDUCING WIRING DENSITY IN HIGH-SPEED DIGITAL SYSTEMS	7
<i>Mahesh Bohra ; Jinwoo Choi ; Yanyan Zhang ; Lloyd Walls</i>	
A NOVEL USE OF DEEP LEARNING TO OPTIMIZE SOLUTION SPACE EXPLORATION FOR SIGNAL INTEGRITY ANALYSIS	10
<i>Mruganka Kashyap ; Kumar Keshavan ; Ambrish Varma</i>	
IMPACT OF READ ENABLE (RE) SIGNAL DUTY CYCLE DISTORTION (DCD) IN NAND FLASH SI SIMULATION	13
<i>Sayed Mobin ; Balaji Raghunathan ; Arkady Katz</i>	
PLATFORM PI-PD CO-DESIGN AND VALIDATION FOR POWER EFFICIENT HSIO INTERFACES	17
<i>Xingjian Kinger Cai ; Sze Geat Pang ; Jimmy Huat Since Huang ; Yan Li ; Steven Yun Ji</i>	
UNIFIED APPROACH TO INTERCONNECT CONDUCTOR SURFACE ROUGHNESS MODELLING	20
<i>Yuriy Shlepnev</i>	
SUPPRESSION OF RADIATED ELECTROMAGNETIC EMISSIONS USING ABSORBING FREQUENCY SELECTIVE SURFACES	23
<i>Ali Khoshniat ; Ramesh Abhari</i>	
DESIGN OPTIMIZATION OF A PLANAR SPIRAL INDUCTOR USING SPACE MAPPING	26
<i>Felipe De J. Leal-Romo ; Marisol Cabrera-Gómez ; José E. Rayas-Sánchez ; Daniel M. García-Mora</i>	
LPDDR4X (3732 MBPS) DBI IMPACT ON SI/PI AND POWER	29
<i>Sunil Gupta</i>	
DISTRIBUTED SINUSOIDAL RESONANT CONVERTER WITH HIGH STEP-DOWN RATIO	33
<i>Kan Xu ; Boris Vaisband ; Gregory Sizikov ; Xin Li ; Eby G. Friedman</i>	
ACCURATE AND EFFICIENT IMPEDANCE MATCHING METHOD IN THE PRESENCE OF ON-BOARD AND SMT PARASITIC COMPONENTS	36
<i>Tao Wang ; Tim Michalka ; Gerardo Romo Luevano</i>	
BIVARIATE MACROMODELING WITH GUARANTEED UNIFORM STABILITY AND PASSIVITY	39
<i>Stefano Grivet-Talocia</i>	
INVESTIGATION OF THE RADIATION MECHANISM FOR HIGH-SPEED CONNECTORS	42
<i>Xu Wang ; Ying S. Cao ; Lijun Jiang ; Albert E. Ruehli ; Shiquan He ; Huapeng Zhao ; Jun Hu ; Jun Fan ; James. L. Drewniak</i>	
A SUPER BROADBAND DGS-BASED COMMON-MODE FILTER WITH A COMPACT DIMENSION	45
<i>Po-Jui Li ; Tzong-Lin Wu</i>	
FIELD-CIRCUIT COEXTRACTION OF SYSTEMS WITH INTERCONNECTS AND CIRCUIT COMPONENTS	48
<i>Jian Liu ; Kaiyu Mao ; Xiande Cao ; Yingxin Sun ; Anyu Kuo</i>	
A METHOD FOR CREATING BEHAVIORAL MODELS OF OSCILLATORS USING AUGMENTED NEURAL NETWORKS	51
<i>Huan Yu ; Madhavan Swaminathan ; Chuanyi Ji ; David White</i>	
ANALYTICAL EVALUATION OF PARTIAL INDUCTANCES WITH RETARDATION	54
<i>L. Lombardi ; G. Antonini ; A. E. Ruehli</i>	
MIXED EPISTEMIC-ALEATORY UNCERTAINTY QUANTIFICATION USING REDUCED DIMENSIONAL POLYNOMIAL CHAOS AND PARAMETRIC ANOVA	57
<i>Aditi K. Prasad ; Sourajeet Roy</i>	
DISCONTINUOUS GALERKIN TIME-DOMAIN ANALYSIS OF POWER/GROUND PLATE PAIRS WITH WAVE PORT EXCITATION	60
<i>Ping Li ; Li Jun Jiang ; Hakan Bagci</i>	

SIGNAL INTEGRITY ANALYSIS OF HIGH-SPEED BOARD-TO-BOARD FLOATING CONNECTORS FOR AUTOMOTIVE SYSTEMS	63
<i>Shinyoung Park ; Hyesoo Kim ; Jonghoon Kim ; Jounggho Kim ; Unho Kim ; Jungmin Park ; Yuckhwan Jeon</i>	
MAXIMUM POWER SPECIFICATION MANAGEMENT FEATURE IN INTEL XEON CPUS	66
<i>Nazar S. Haider ; Aman Sewani</i>	
CAUSAL VERSION OF CONDUCTOR ROUGHNESS MODELS AND ITS EFFECT ON CHARACTERISTICS OF TRANSMISSION LINES.....	69
<i>Vladimir Dmitriev-Zdorov ; Lambert Simonovich</i>	
USING DEEP NEURAL NETWORKS TO MODEL NONLINEAR CIRCUIT BLOCKS IN WIRELINE LINKS.....	72
<i>Arash Zargaran-Yazd ; Sunil Sudhakaran</i>	
MODELING OF DDR5 SIGNALING FROM JITTER SEQUENCES TO ACCURATE BIT ERROR RATE (BER)	75
<i>Alaeddin A. Aydinier ; Yunhui Chu ; Oleg Mikulchenko ; Jin Yan ; Robert J. Friar ; Ellen Yan Fu</i>	
SIGNAL SLOPE MODULATION METHOD FOR HIGH DATA TRANSFER RATES AND REDUCING WIRING DENSITY IN HIGH-SPEED DIGITAL SYSTEMS	78
<i>Mahesh Bohra ; Jinwoo Choi ; Yanyan Zhang ; Lloyd Walls</i>	
A NOVEL TENSOR-BASED MODEL COMPRESSION METHOD VIA TUCKER AND TENSOR TRAIN DECOMPOSITIONS.....	81
<i>Cong Chen ; Kim Batselier ; Ngai Wong</i>	
ACCELERATION OF SHIELDING EFFECTIVENESS ANALYSIS USING STABLE FDTD SUBGRIDDING.....	84
<i>Fadime Bekmambetova ; Xinyue Zhang ; Piero Triverio</i>	
MIP: MOMENT-BASED INTERPOLATION PROJECTION FOR PARAMETERIZED REDUCED MODELS OF THE DC OPERATING POINT IN NONLINEAR CIRCUITS	87
<i>Y. Tao ; B. Nouri ; E. Gad ; M. Nakhla ; Q. Sun ; R. Achar</i>	
ANALYSIS OF INTEGRATED METAL SEAL RING RESONANCE	90
<i>Maxime Jacques ; David Denis ; Stéphane Bouvier ; Alireza Samani ; Faycal Mounaim ; David V. Plant</i>	
EVALUATION OF CONCATENATION TECHNIQUES FOR STATE-SPACE INTERCONNECT MACROMODELS	93
<i>Luis Ernesto Carrera-Retana ; Renato Rimolo-Donadio ; Christian Schuster</i>	
ADAPTIVE WAVELET STOCHASTIC COLLOCATION FOR RESONANT TRANSMISSION LINE CIRCUITS.....	96
<i>Alan S. Yang ; Xu Chen ; José E. Schutt-Ainé ; Andreas C. Cangellaris</i>	
VIA OPTIMIZATION FOR NEXT GENERATION SPEEDS	99
<i>Siang Chen ; Carol Chen ; Chun-Lin Liao ; James Chen ; Tzong-Lin Wu ; Bhyrav Mutnury</i>	
THE ACCURACY OF PORT CONNECTIONS BETWEEN LAYERS IN PRINTED CIRCUIT BOARD.....	102
<i>Siqi Bai ; Chenxi Huang ; Albert E. Ruehli ; Stephen Scearce ; James L. Drewniak</i>	
IMPROVE MM-WAVE MEASUREMENT REPEATABILITY AND ACCURACY BY INCREASING COAXIAL CONNECTOR PIN GAP	105
<i>Ken Wong ; Johannes Hoffmann</i>	
HIGH-SPEED CHANNEL MODELING WITH DEEP NEURAL NETWORK FOR SIGNAL INTEGRITY ANALYSIS	108
<i>Tianjian Lu ; Ken Wu ; Zhiping Yang ; Ju Sun</i>	
INDUCTANCE MODEL OF DECOUPLING CAPACITORS INCLUDING THE LOCAL ENVIRONMENT	111
<i>Tamar Makharashvili ; Ying S. Cao ; Albert E. Ruehli ; James Drewniak ; Daryl G. Beetner</i>	
SIGNAL INTEGRITY ANALYSIS OF MACHINE PRESSED COAXIAL CONNECTOR FOR AUTOMOTIVE SYSTEM.....	114
<i>Dong-Hyun Kim ; Hyunsuk Lee ; Jonghoon Kim ; Jounggho Kim ; Jung-Min Park ; Un-Ho Kim ; Kun-Ho Kim ; Yeok-Hwan Jeon ; Hyeok-Cheol Kwon ; Hoon Kim ; Maeng-Ki Song</i>	
BOOSTING OFF-CHIP INTERCONNECTS THROUGH CHIP-TO-CHIP CAPACITIVE COUPLED COMMUNICATION	117
<i>Xiang Zhang ; Dongwon Park ; Chung-Kuan Cheng</i>	
SIGNAL VIA COUPLING EFFECTS CAUSED BY PARTIALLY BROKEN HIGH FREQUENCY SIGNAL RETURN	120
<i>Thomas-Michael Winkel</i>	
FULL-WAVE ELECTROMAGNETIC CHARACTERIZATION OF 3D INTERCONNECTS USING A SURFACE INTEGRAL FORMULATION.....	124
<i>Utkarsh R. Patel ; Shashwat Sharma ; Shunchuan Yang ; Sean V. Hum ; Piero Triverio</i>	

A SIMPLE METHOD TO IMPROVE SIGNAL INTEGRITY OF ELECTROSTATIC DISCHARGE PROTECTION DEVICES.....	127
<i>Yang-Chih Huang ; Chin-Yi Lin ; Tzong-Lin Wu</i>	
NOISE BASED RAIL ISOLATION DETERMINATION IN SPATIALLY DISTRIBUTED IVR PDNS.....	130
<i>Chin Lee Kuan ; Amit K. Jain ; Sameer Shekhar ; Sanjiv C. Soman</i>	
TOWARD VIRTUAL PROTOTYPING OF POWER ELECTRONICS: MODEL ORDER REDUCTION FOR TIGHT-COUPLED ELECTRO-THERMAL SIMULATION.....	133
<i>Ngai Wong ; Quan Chen</i>	
COST FUNCTION IMPACT ON S-PARAMETER OPTIMIZATION SPACE.....	136
<i>Daniel N. De Araújo ; James Pingenot</i>	
VERILOG-A COMPATIBLE RECURRENT NEURAL NETWORK MODEL FOR TRANSIENT CIRCUIT SIMULATION.....	139
<i>Zaichen Chen ; Maxim Raginsky ; Elyse Rosenbaum</i>	
INTERPOLATING INDUCTANCE COUPLING EFFECTS FOR PACKAGE AND PCB SIMULATION.....	142
<i>Xin Xu ; Werner Thiel ; J. Eric Bracken</i>	
STITCHING IMPEDANCE ANALYSIS OF LPDDR POWER PLANE SPLIT AND ITS IMPACT TO RADIO FREQUENCY INTERFERENCE (RFI) AND SIGNAL INTEGRITY (SI).....	145
<i>Ying-Ern Ho ; Hao-Han Hsu ; Jun Liao ; Xingjian Cai</i>	
SENSITIVITY OF NRZ AND PAM4 SIGNALING SCHEMES TO CHANNEL INSERTION LOSS DEVIATION.....	148
<i>Giorgi Maghlakelidze ; Santhosh Ranga Chavalla ; Nana Dikhaminjia ; James Drewniak</i>	
SUBSTRATE INTEGRATED COMMON MODE CHOKE OF EMI FILTER FOR HIGH SPEED SERIAL LINK.....	151
<i>Boping Wu</i>	
PER-BIT EQUALIZATION APPROACH FOR MULTI-LEVEL SIGNAL IN HIGH-SPEED DESIGN.....	154
<i>J. He ; H. Deng ; N. Dikhaminjia ; M. Tsiklauri ; J. Drewniak ; A. Chada ; B. Mutnury</i>	
CHIP/PACKAGE CO-ANALYSIS AND INDUCTANCE EXTRACTION FOR FAN-OUT WAFER-LEVEL-PACKAGING.....	157
<i>Yarui Peng ; Dusan Petranovic ; Sung Kyu Lim</i>	
EFFECT OF NEXT COUPLING IN CLOSE PROXIMITY TO RECEIVER OF 25GB/S BUS.....	160
<i>Pavel Roy Paladhi ; Jose Hejase ; Nam Pham ; Ghadir Gholami ; Prasanna Jayaraman ; Megan Nguyen ; Glen Wiedemeier ; Daniel Dreps</i>	
SYSTEM-LEVEL COEXISTENCE IMPACT OF USB TYPE-C AND TYPE-A CONNECTORS WITH WIFI RADIO.....	163
<i>Jaejin Lee ; Hao-Han Hsu ; Chung-Hao Chen ; Xiang Li ; Xingjian Kinger Cai</i>	
DC BLOCKING CAPACITOR INTERFACING FOR HIGH SPEED COMMUNICATION BUSES.....	166
<i>Junyan Tang ; Jose A. Hejase ; Matthew Richardson ; Daniel M. Dreps ; Wiren D. Becker ; Young H. Kwark ; Jean Audet ; Christian W. Baks</i>	
EMBEDDED FILTERING IN PCB INTEGRATED ULTRA HIGH SPEED DIELECTRIC WAVEGUIDES USING PHOTONIC BAND GAP STRUCTURES.....	169
<i>Joshua C. Myers ; Jose A. Hejase ; Junyan Tang ; Daniel M. Dreps</i>	
A NEW APPROACH TO MITIGATE PCI EXPRESS GEN4 CROSSTALK FROM SIDEBAND SIGNALS IN CONNECTORS.....	172
<i>Yaping Zhou ; Wenjun Shi ; Sunil Sudhakaran</i>	
AN INDIRECT MEASUREMENT METHOD FOR S-PARAMETERS WHICH IS BASED ON REDUCTION TO EIGENVALUE PROBLEM.....	175
<i>Noboru Maeda ; Shinji Fukui ; Toshikazu Sekine ; Yasuhiro Takahashi</i>	
FASTAAA: A FAST RATIONAL-FUNCTION FITTER.....	178
<i>Amit Hochman</i>	
EFFECT OF TIME DELAY SKEW ON DIFFERENTIAL INSERTION LOSS IN WEAK AND STRONG COUPLED PCB TRACES.....	181
<i>David Nozadze ; Amendra Koul ; Kartheek Nalla ; Mike Sapozhnikov ; Victor Khilkevich</i>	
REDUCED PIN COMMAND AND ADDRESS BUS FOR LPDDR4X USING EQUALIZATION TECHNIQUE.....	184
<i>Jun Liao ; Konika Ganguly ; Roman Meltser ; Jennifer Duong ; Stephen P Christianson ; Xingjian Cai</i>	
A PARALLEL ITERATIVE LAYERED-MEDIUM INTEGRAL-EQUATION SOLVER FOR ELECTROMAGNETIC ANALYSIS OF ELECTRONIC PACKAGES.....	187
<i>C. Liu ; K. Aygün ; H. Braunisch ; V. I. Okhmatovski ; A. E. Yilmaz</i>	

VERIFYING THE ACCURACY OF 2X-THRU DE-EMBEDDING FOR UNSYMMETRICAL TEST FIXTURES.....	190
<i>Heidi Barnes ; Jose Moreira</i>	
A HYBRID LAND GRID ARRAY SOCKET CONNECTOR DESIGN FOR ACHIEVING HIGHER SIGNALLING DATA RATES	193
<i>Jose A. Hejase ; Sungjun Chun ; Wiren D. Becker ; Daniel M. Dreps ; Brian S. Beaman</i>	
OUTPUT IMPEDANCE DESIGN OF DISTRIBUTED DOMAINS WITH HIGH FREQUENCY VOLTAGE REGULATORS	196
<i>Amit K. Jain ; Chin Lee Kuan ; Sameer Shekhar</i>	
A NOVEL STOCHASTIC WAVE MODEL STATISTICALLY REPLICATING REVERBERATION CHAMBERS	199
<i>Shen Lin ; Zhen Peng</i>	
EMI RADIATION PHYSICS USING GENERALIZED CHARACTERISTIC MODE (GCM) ANALYSIS WITH LOSS FOR PRACTICAL STRUCTURES	202
<i>Ying S. Cao ; Xu Wang ; Yansheng Wang ; Lijun Jiang ; Albert E. Ruehli ; Shiquan He ; Huapeng Zhao ; Jun Hu ; Jun Fan ; James. L. Drewniak</i>	
SAS 4.0 (22.5GBPS) CHALLENGES FOR SERVER PLATFORMS	205
<i>Vijender Kumar ; Gowri Anand ; Sanjay Kumar ; Mallikarjun Vasa ; Doug Wallace ; Bhyrav Mutnury</i>	
COMPUTATION OF THE X-PARAMETERS OF MULTI-TONE CIRCUITS USING MULTIPOINT MOMENT EXPANSION	208
<i>Marco T. Kassis ; Dani Tannir ; Raffi Toukhtarian ; Roni Khazaka</i>	
REDUCED-ORDER MODELING OF HIGH-SPEED CHANNELS USING MACHINE LEARNING TECHNIQUES: PARTITIONAL AND HIERARCHICAL CLUSTERINGS	211
<i>Wendemagengnehu Tsegaye Beyene</i>	
Author Index	